# onsemi

## Silicon Carbide (SiC) MOSFET – 20 mohm, 900 V, M2, TO-247-3L

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> MAX | I <sub>D</sub> MAX |
|----------------------|-------------------------|--------------------|
| 900 V                | 28 mΩ @ 15 V            | 118 A              |

## NVHL020N090SC1

#### Features

- Typ.  $R_{DS(on)} = 20 \text{ m}\Omega @ V_{GS} = 15 \text{ V}$
- Typ.  $R_{DS(on)} = 16 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge (typ. Q<sub>G(tot)</sub> = 196 nC)
- Low Effective Output Capacitance (typ. Coss = 296 pF)
- 100% UIL Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

#### **Typical Applications**

- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Parameter                                                                                      |                                                                    |                     | Symbol                            | Value          | Unit |
|------------------------------------------------------------------------------------------------|--------------------------------------------------------------------|---------------------|-----------------------------------|----------------|------|
| Drain-to-Source Voltage                                                                        |                                                                    | V <sub>DSS</sub>    | 900                               | V              |      |
| Gate-to-Source Voltag                                                                          | ge                                                                 |                     | V <sub>GS</sub>                   | +22/-8         | V    |
| Recommended Operat<br>Values of Gate-Source                                                    |                                                                    |                     | V <sub>GSop</sub>                 | +15/-5         | V    |
| $\begin{array}{l} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$        | Steady<br>State                                                    | $T_C = 25^{\circ}C$ | I <sub>DC</sub>                   | 118            | А    |
| Power Dissipation $R_{\theta JC}$                                                              |                                                                    |                     | P <sub>DC</sub>                   | 503            | W    |
| $\begin{array}{l} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$        | Steady T <sub>C</sub> = 100°C<br>State                             |                     | I <sub>DC</sub>                   | 83             | А    |
| Power Dissipation $R_{\theta JC}$                                                              |                                                                    |                     | P <sub>DC</sub>                   | 251            | W    |
| Pulsed Drain Current (                                                                         | Note 2)                                                            | $T_A = 25^{\circ}C$ | I <sub>DM</sub>                   | 472            | А    |
| Single Pulse Surge<br>Drain Current<br>Capability(Note 3)                                      | $T_{A} = 25^{\circ}C, t_{p} = 10 \ \mu s, \\ R_{G} = 4.7 \ \Omega$ |                     | I <sub>DSC</sub>                  | 854            | A    |
| Operating Junction and Range                                                                   | perating Junction and Storage Temperature ange                     |                     | T <sub>J</sub> , T <sub>stg</sub> | –55 to<br>+175 | °C   |
| Source Current (Body Diode)                                                                    |                                                                    | Is                  | 153                               | А              |      |
| Single Pulse Drain-to-Source Avalanche Energy ( $I_L = 23 A_{pk}, L = 1 \text{ mH}$ ) (Note 4) |                                                                    | E <sub>AS</sub>     | 264                               | mJ             |      |

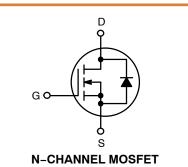
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. Peak current might be limited by transconductance.

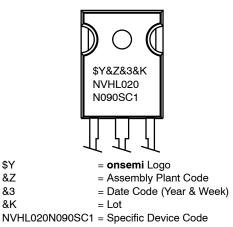
4. EAS of 264 mJ is based on starting TJ = 25°C; L = 1 mH, IAS = 23 A,  $V_{DD} = 100 \text{ V}, V_{GS} = 15 \text{ V}.$ 





**TO-247 LONG LEADS** CASE 340CX

#### MARKING DIAGRAM



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&Z &3

#### **ORDERING INFORMATION**

| Device         | Package             | Shipping           |
|----------------|---------------------|--------------------|
| NVHL020N090SC1 | TO-247<br>Long Lead | 30 Units /<br>Tube |

#### Table 1. THERMAL CHARACTERISTICS

| Parameter                                       | Symbol          | Мах  | Units |
|-------------------------------------------------|-----------------|------|-------|
| Thermal Resistance Junction-to-Case (Note 1)    | $R_{\theta JC}$ | 0.30 | °C/W  |
| Thermal Resistance Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 40   | °C/W  |

#### Table 2. ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

| Parameter                                                    | Symbol                                                 | Test                                                                                                                                                                                | Condition                | Min      | Тур  | Max | Unit  |
|--------------------------------------------------------------|--------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|----------|------|-----|-------|
| OFF CHARACTERISTICS                                          |                                                        |                                                                                                                                                                                     |                          |          |      |     |       |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                                   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA                                                                                                                                        |                          | 900      |      |     | V     |
| Drain-to-Source Breakdown Voltage<br>Temperature Coefficient | V <sub>(BR)DSS</sub> /T <sub>J</sub>                   | I <sub>D</sub> = 1 mA, refer to 25°C                                                                                                                                                |                          |          | 500  |     | mV/°C |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                                       | S $V_{GS} = 0 V,$ $T_J = 25^{\circ}C$                                                                                                                                               |                          |          | 100  | μΑ  |       |
|                                                              | $V_{DS} = 900 \text{ V}$ $T_{J} = 175^{\circ}\text{C}$ | T <sub>J</sub> = 175°C                                                                                                                                                              |                          |          | 250  | μΑ  |       |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                                       | V <sub>GS</sub> = +22/-8 \                                                                                                                                                          | /, V <sub>DS</sub> = 0 V |          |      | ±1  | μΑ    |
| ON CHARACTERISTICS                                           |                                                        |                                                                                                                                                                                     |                          |          |      |     |       |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                                    | $V_{GS} = V_{DS}$ , $I_D$                                                                                                                                                           | = 20 mA                  | 1.8      | 2.7  | 4.3 | V     |
| Recommended Gate Voltage                                     | V <sub>GOP</sub>                                       |                                                                                                                                                                                     |                          | -5       |      | +15 | V     |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                                    | $V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 18 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ |                          |          | 20   | 28  | mΩ    |
|                                                              |                                                        |                                                                                                                                                                                     |                          |          | 16   |     |       |
|                                                              |                                                        | $V_{GS}$ = 15 V, I <sub>D</sub> = 60 A, T <sub>J</sub> = 175°C                                                                                                                      |                          | 27       |      |     |       |
| Forward Transconductance                                     | 9 <sub>FS</sub>                                        | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 60 A                                                                                                                                       |                          |          | 49   |     | S     |
| CHARGES, CAPACITANCES & GATE R                               | ESISTANCE                                              |                                                                                                                                                                                     |                          |          |      |     |       |
| Input Capacitance                                            | C <sub>ISS</sub>                                       | $V_{GS} = 0 V, f = 1$                                                                                                                                                               | MHz,                     |          | 4415 |     | pF    |
| Output Capacitance                                           | C <sub>OSS</sub>                                       | V <sub>DS</sub> = 450 V                                                                                                                                                             |                          |          | 296  |     |       |
| Reverse Transfer Capacitance                                 | C <sub>RSS</sub>                                       |                                                                                                                                                                                     |                          |          | 24   |     |       |
| Total Gate Charge                                            | Q <sub>G(TOT)</sub>                                    | $V_{GS} = -5/15 V,$                                                                                                                                                                 | V <sub>DS</sub> = 720 V, |          | 196  |     | nC    |
| Threshold Gate Charge                                        | Q <sub>G(TH)</sub>                                     | I <sub>D</sub> = 60 A                                                                                                                                                               |                          |          | 42   |     |       |
| Gate-to-Source Charge                                        | Q <sub>GS</sub>                                        |                                                                                                                                                                                     |                          |          | 78   |     |       |
| Gate-to-Drain Charge                                         | Q <sub>GD</sub>                                        | 1                                                                                                                                                                                   |                          |          | 55   |     |       |
| Gate-Resistance                                              | R <sub>G</sub>                                         | f = 1 MHz                                                                                                                                                                           |                          |          | 1.6  |     | Ω     |
| SWITCHING CHARACTERISTICS                                    |                                                        |                                                                                                                                                                                     |                          | -        | •    |     |       |
| Turn-On Delay Time                                           | t <sub>d(ON)</sub>                                     | V <sub>GS</sub> = -5/15 V,                                                                                                                                                          |                          |          | 40   |     | ns    |
| Rise Time                                                    | t <sub>r</sub>                                         | $I_D$ = 60 A, $R_G$ = 2.5 $\Omega$ ,<br>Inductive Load                                                                                                                              |                          |          | 63   |     |       |
| Turn-Off Delay Time                                          |                                                        |                                                                                                                                                                                     |                          | <u> </u> | 55   | l   |       |

|                                 | ۲                   | Inductive Load | 03   |    |
|---------------------------------|---------------------|----------------|------|----|
| Turn-Off Delay Time             | t <sub>d(OFF)</sub> |                | 55   |    |
| Fall Time                       | t <sub>f</sub>      |                | 13   |    |
| Turn-On Switching Loss          | E <sub>ON</sub>     |                | 2025 | μJ |
| Turn-Off Switching Loss         | E <sub>OFF</sub>    |                | 201  |    |
| Total Switching Loss            | E <sub>TOT</sub>    |                | 2226 |    |
| DRAIN-SOURCE DIODE CHARACTERIST | CS                  |                |      |    |

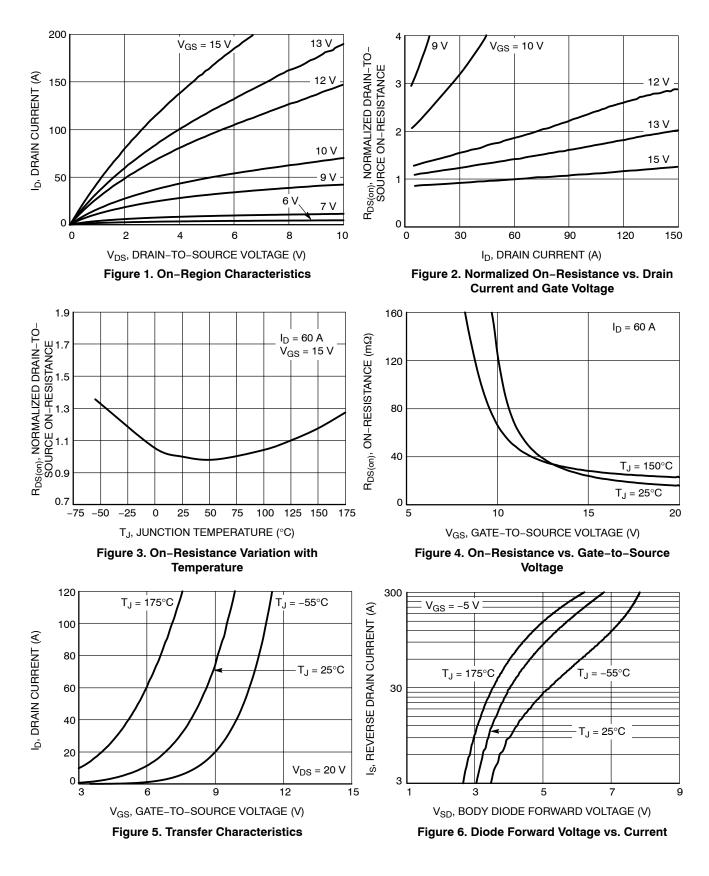
| Continuous Drain-Source Diode Forward<br>Current      | I <sub>SD</sub>  | $V_{GS}$ = -5 V, $T_{J}$ = 25°C                                |     | 153 | А |
|-------------------------------------------------------|------------------|----------------------------------------------------------------|-----|-----|---|
| Pulsed Drain-Source Diode Forward<br>Current (Note 2) | I <sub>SDM</sub> | $V_{GS}$ = -5 V, $T_{J}$ = 25°C                                |     | 472 | A |
| Forward Diode Voltage                                 | V <sub>SD</sub>  | $V_{GS}$ = -5 V, I <sub>SD</sub> = 30 A, T <sub>J</sub> = 25°C | 3.8 |     | V |

#### Table 2. ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = $25^{\circ}C$ unless otherwise stated)

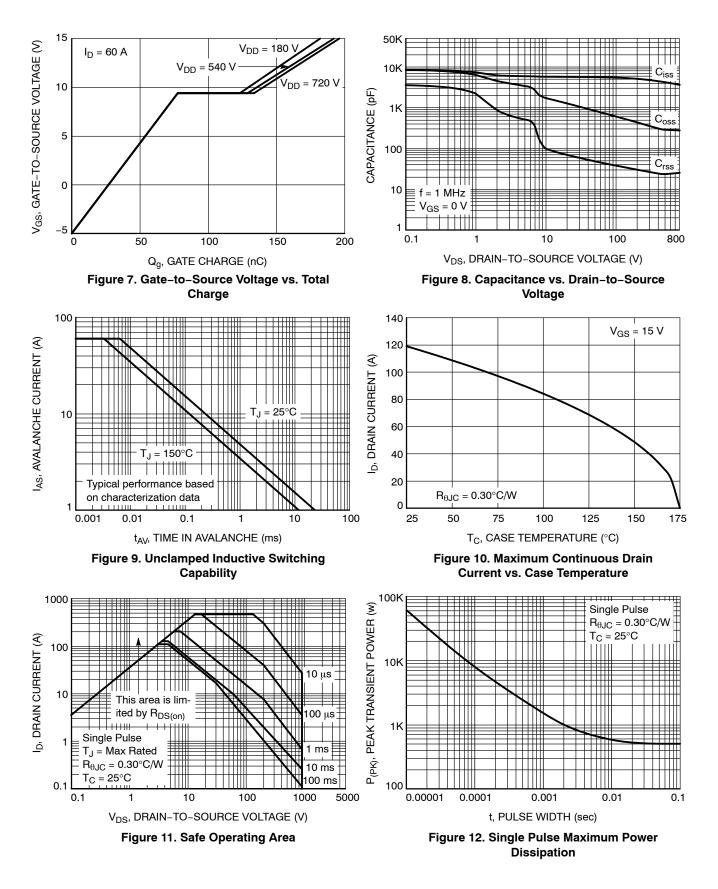
| Parameter                          | Symbol           | Test Condition                                           | Min | Тур | Мах | Unit |  |  |
|------------------------------------|------------------|----------------------------------------------------------|-----|-----|-----|------|--|--|
| DRAIN-SOURCE DIODE CHARACTERISTICS |                  |                                                          |     |     |     |      |  |  |
| Reverse Recovery Time              | t <sub>RR</sub>  | $V_{GS} = -5/15 \text{ V}, I_{SD} = 60 \text{ A},$       |     | 28  |     | ns   |  |  |
| Reverse Recovery Charge            | Q <sub>RR</sub>  | dl <sub>S</sub> /dt = 1000 Å/µs, V <sub>DS</sub> = 720 V |     | 199 |     | nC   |  |  |
| Reverse Recovery Energy            | E <sub>REC</sub> |                                                          |     | 4   |     | μJ   |  |  |
| Peak Reverse Recovery Current      | I <sub>RRM</sub> | 1                                                        |     | 14  |     | А    |  |  |
| Charge Time                        | Та               | 1                                                        |     | 16  |     | ns   |  |  |
| Discharge Time                     | Tb               | ]                                                        |     | 12  |     | ns   |  |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**



#### TYPICAL CHARACTERISTICS (continued)



#### TYPICAL CHARACTERISTICS (continued)

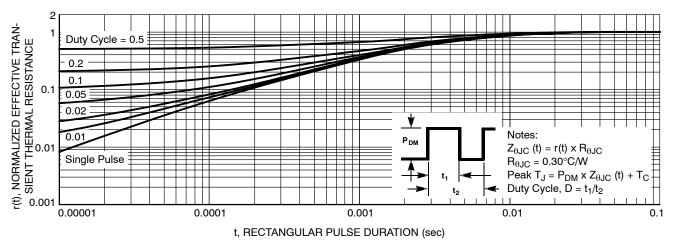
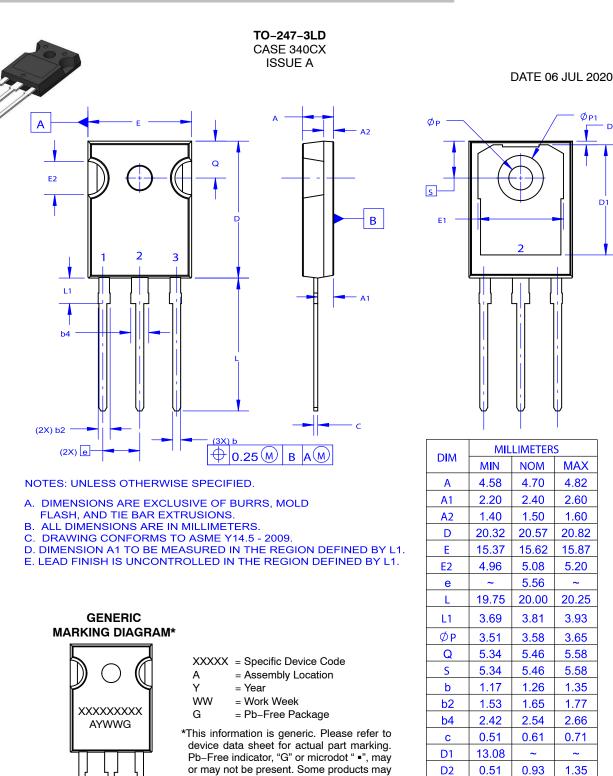


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



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